

Pb Free Plating Product

2SK3878



THINKISEMI 9A,900V N-CHANNEL PLANAR STRIPE POWER MOSFETS

<p><b>Features</b></p> <ul style="list-style-type: none"> <li>※ Low ON Resistance</li> <li>※ Low Gate Charge</li> <li>※ Peak Current vs Pulse Width Curve</li> <li>※ ESD Capability Improved</li> <li>※ 100% Avalanche Tested</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>※ Uninterruptible Power Supply(UPS)</li> <li>※ LCD Panel Power</li> <li>※ DC-AC Inverter, Amplifier and SMPS</li> </ul> <p><b>Mechanical Data</b></p> <ul style="list-style-type: none"> <li>※ Case: TO-3P non-isolated package</li> <li>※ Epoxy: UL 94V-0 rate flame retardant</li> <li>※ Terminals: Solderable per MIL-STD-202 method 208</li> <li>※ Polarity: As per configuration</li> <li>※ Mounting position: Any</li> <li>※ Weight: 6.0 gram approximately</li> </ul>	<p>TO-3P pkg outline &amp; internal configuration</p> <p>Schematic Diagram</p>
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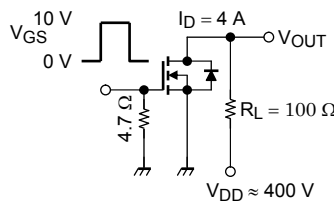
**Absolute Maximum Ratings (Ta = 25°C)**

Characteristic		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	900	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	900	V
Gate-source voltage		$V_{GSS}$	$\pm 30$	V
Drain current	DC (Note 1)	$I_D$	9	A
	Pulse (Note 1)	$I_{DP}$	27	
Drain power dissipation ( $T_c = 25^\circ\text{C}$ )		$P_D$	150	W
Single pulse avalanche energy (Note 2)		$E_{AS}$	778	mJ
Avalanche current		$I_{AR}$	9	A
Repetitive avalanche energy (Note 3)		$E_{AR}$	15	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-55 to 150	$^\circ\text{C}$

**Thermal Characteristics**

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	0.833	$^\circ\text{C/W}$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	50	$^\circ\text{C/W}$

### Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit	
Gate leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±30 V, V <sub>DS</sub> = 0 V	—	—	±10	μA	
Gate-source breakdown voltage	V <sub>(BR) GSS</sub>	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V	±30	—	—	V	
Drain cutoff current	I <sub>DSS</sub>	V <sub>DS</sub> = 720 V, V <sub>GS</sub> = 0 V	—	—	100	μA	
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	900	—	—	V	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	—	4.0	V	
Drain-source ON resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A	—	1.0	1.3	Ω	
Forward transfer admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 4 A	3.5	7.0	—	S	
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	—	2200	—	pF	
Reverse transfer capacitance	C <sub>rss</sub>		—	45	—		
Output capacitance	C <sub>oss</sub>		—	190	—		
Switching time	Rise time	t <sub>r</sub>		—	25	—	ns
	Turn-on time	t <sub>on</sub>		—	65	—	
	Fall time	t <sub>f</sub>		—	20	—	
	Turn-off time	t <sub>off</sub>		Duty ≤ 1%, t <sub>w</sub> = 10 μs	—	120	
Total gate charge (gate-source plus gate-drain)	Q <sub>g</sub>	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A	—	60	—	nC	
Gate-source charge	Q <sub>gs</sub>		—	34	—		
Gate-drain ("Miller") charge	Q <sub>gd</sub>		—	26	—		

### Source-Drain Ratings and Characteristics (Ta = 25°C)

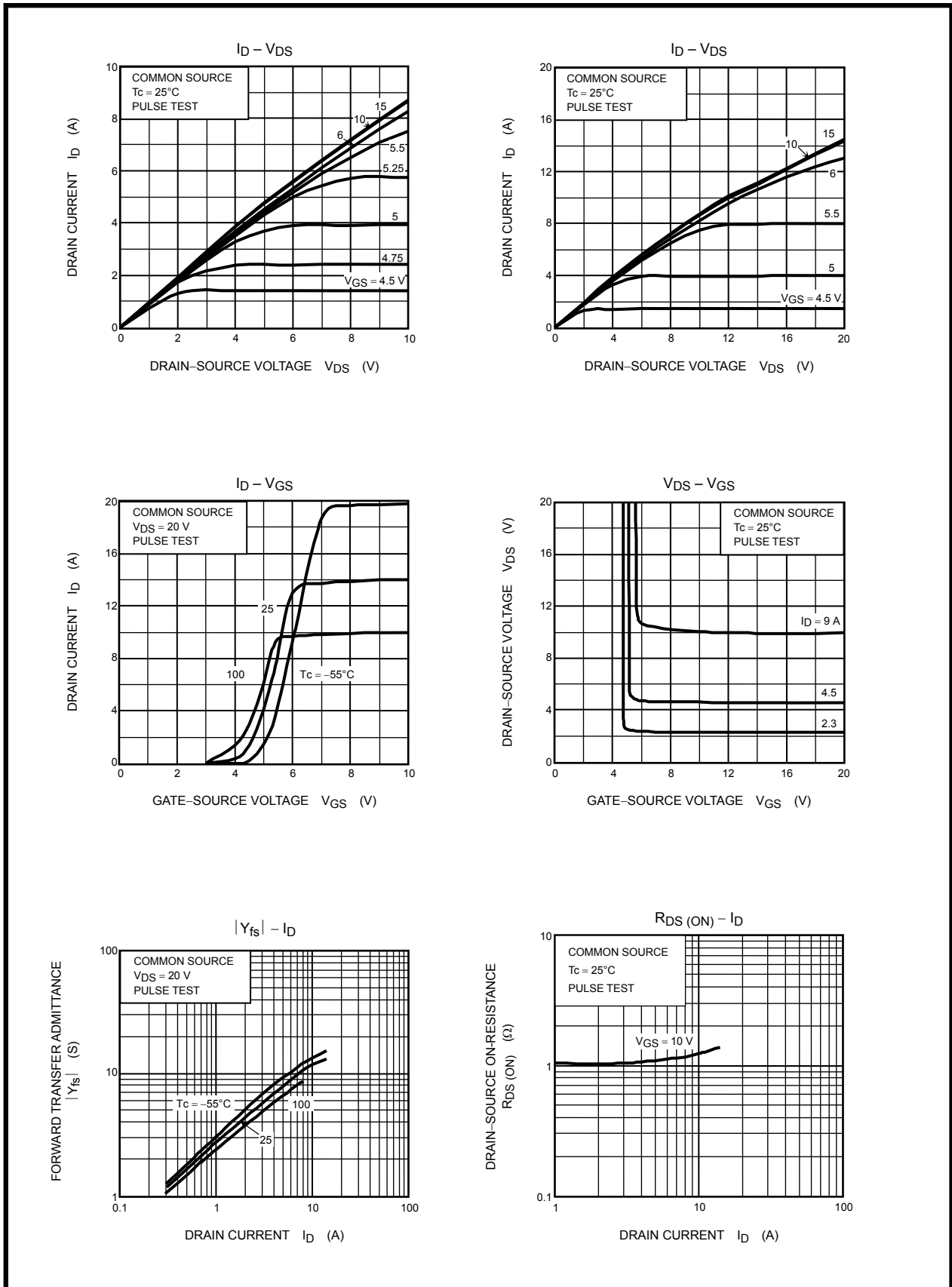
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	—	—	9	A
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	—	—	27	A
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 9 A, V <sub>GS</sub> = 0 V	—	—	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 9 A, V <sub>GS</sub> = 0 V,	—	1.4	—	μs
Reverse recovery charge	Q <sub>rr</sub>	dI <sub>DR</sub> /dt = 100 A/μs	—	16	—	μC

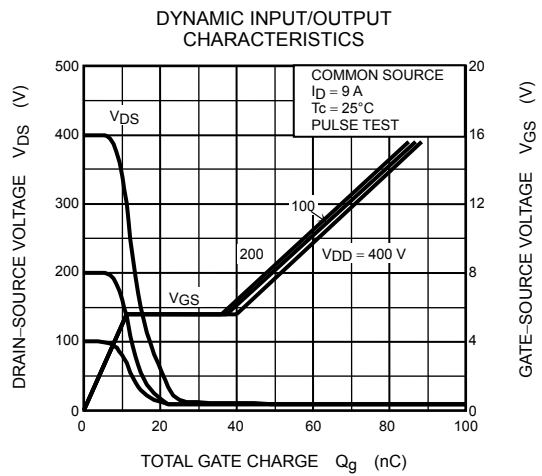
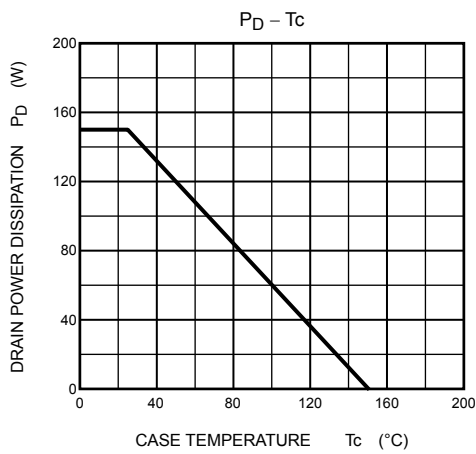
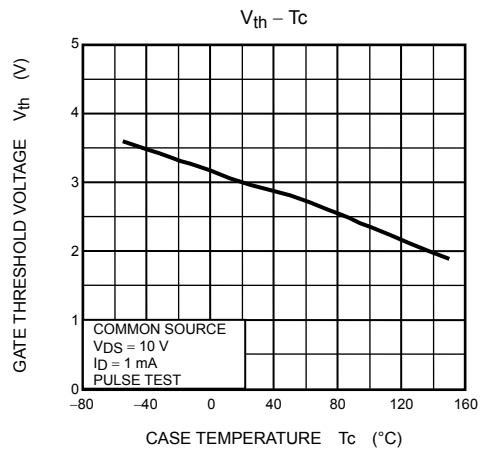
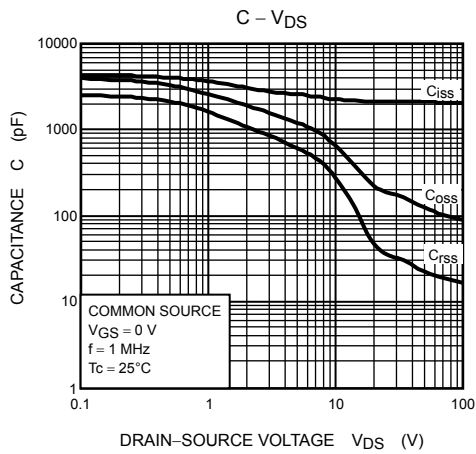
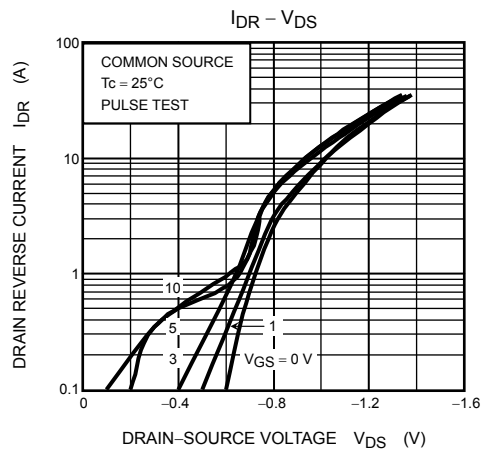
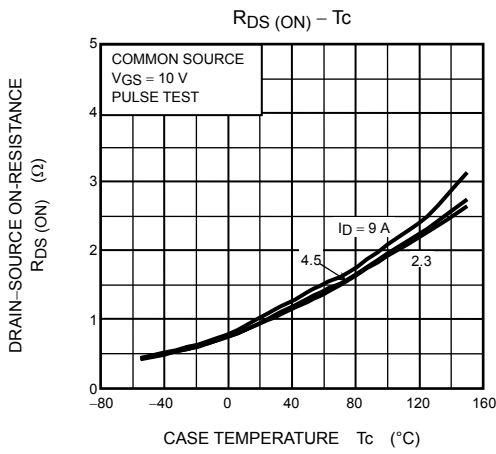
Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

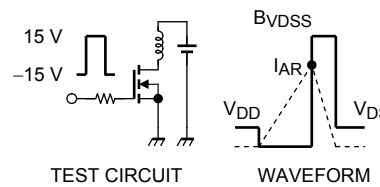
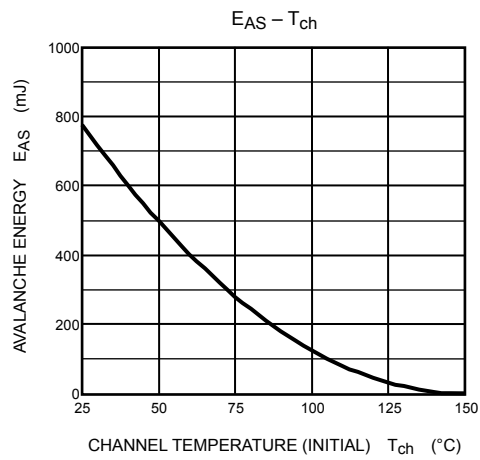
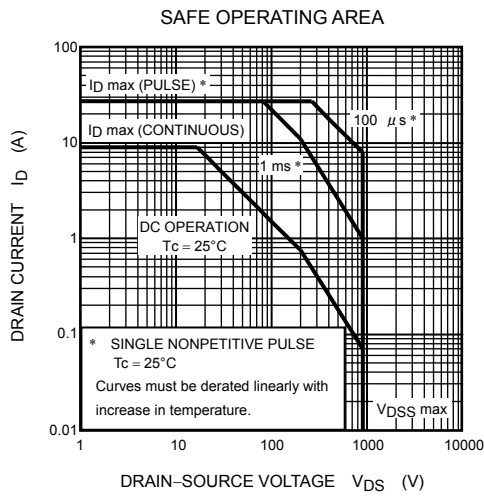
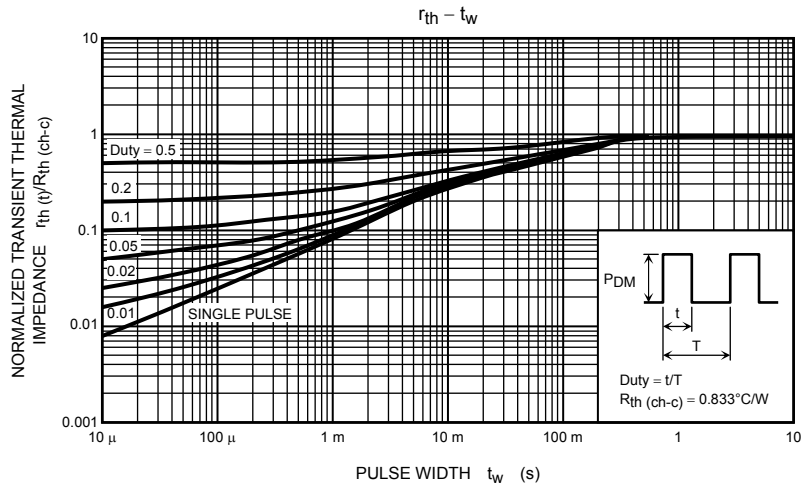
Note 2: V<sub>DD</sub> = 90 V, T<sub>ch</sub> = 25°C, L = 17.6 mH, R<sub>G</sub> = 25 Ω, I<sub>AR</sub> = 9 A

Note 3: Repetitive rating: pulse width limited by max junction temperature

This transistor is an electrostatic-sensitive device. Handle with care.





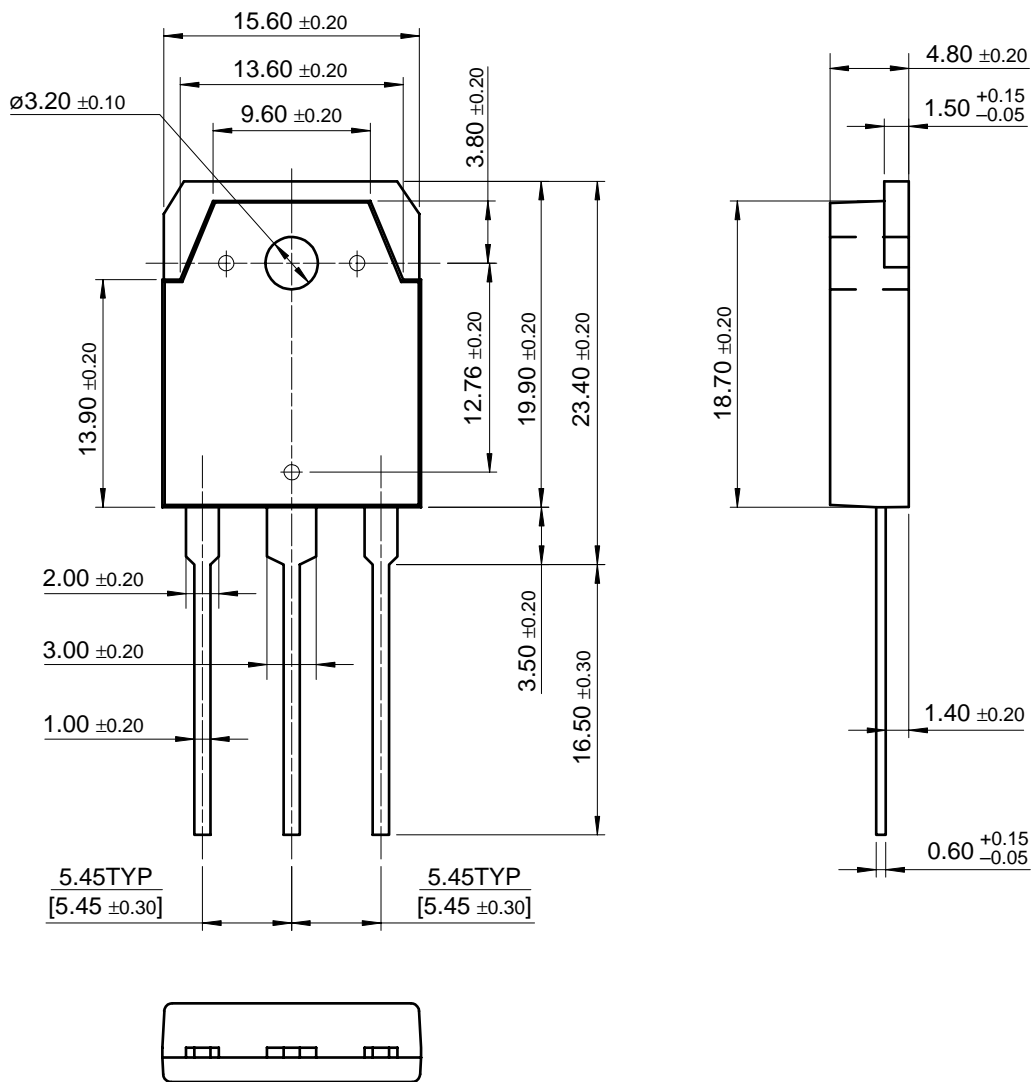


$R_G = 25 \Omega$   
 $V_{DD} = 90 \text{ V}, L = 17.6 \text{ mH}$   

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left( \frac{BV_{DSS}}{BV_{DSS} - V_{DD}} \right)$$

THINKI TO-3P Package Dimensions

TO-3PN-SQ/TO-3PB-SQ



Dimensions in Millimeters